

November 2013

FDMS015N04B N-Channel PowerTrench[®] MOSFET 40 V, 100 A, 1.5 m Ω

Features

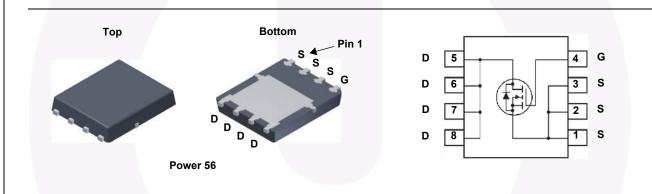
- $R_{DS(on)}$ = 1.13 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 50 A
- Advanced Package and Silicon Combination for Low $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ and High Efficiency
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant

Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FDMS015N04B	Unit			
V _{DSS}	Drain to Source Voltage	40	V			
V _{GSS}	Gate to Source Voltage		±20	V		
ID	Drain Current	- Continuous (T _C = 25 ^o C)		100	٨	
	Drain Current	- Continuous (T _A = 25 ^o C)	(Note 1a)	31.3	A	
l _{DM}	Drain Current	- Pulsed	(Note 2)	400	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 3			526	mJ	
P _D	Rower Dissingtion	(T _C = 25°C)	(T _C = 25°C)		W	
	Power Dissipation	(T _A = 25°C)	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	

Thermal Characteristics

Symbol	Parameter	FDMS015N04B	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.2	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max. (Note 1a)	50	0/00

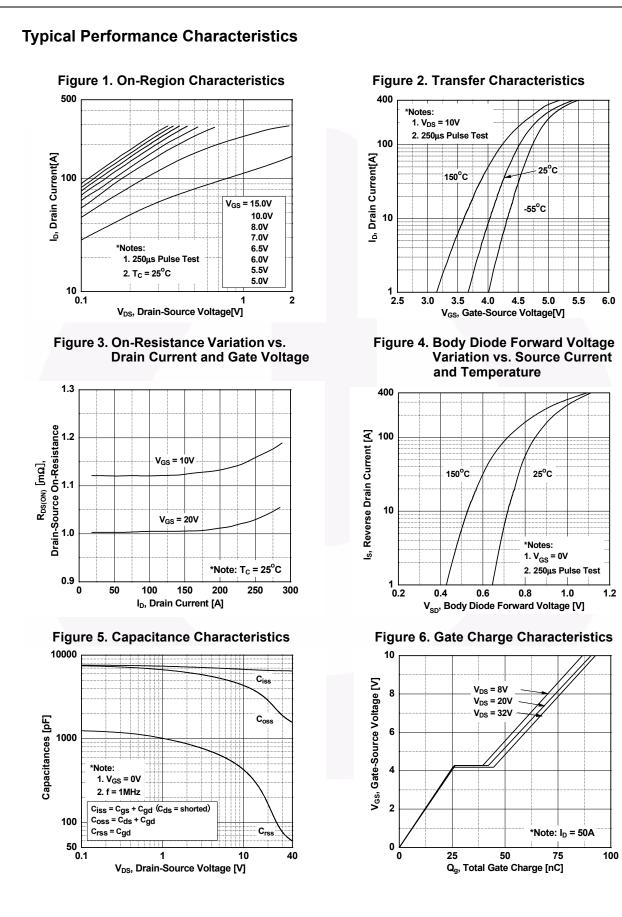
	rking	Device	Packag	le	Reel Size	Таре	e Width		Quantit	ty
FDMS015			Power 5	56	13 "	12	2 mm		3000 units	
Electrica	l Char	acteristics T _c =	25°C unless	otherwise no	ted.					
Symbol		Parameter			est Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S								
BV _{DSS}	Drain to	Source Breakdown Vo	oltage	I _D = 250 μA	, V _{GS} = 0 V		40	-	-	V
ΔBV _{DSS} / ΔT _J	Breakd	Breakdown Voltage Temperature		$I_D = 250 \mu\text{A}$, Referenced to 25°C			-	37	-	mV/º0
		Gate Voltage Drain Current		V _{DS} = 32 V	$V_{GS} = 0 V$		-	-	1	μA
GSS		Gate to Body Leakage Current		$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			-	-	±100	nA
On Charac	torictic	6			20	I				
	-			V - V	1 - 250 4		2.0		4.0	14
V _{GS(th)}		hreshold Voltage	iotonoc		$I_{\rm D} = 250 \mu \text{A}$		2.0	-	4.0	V
R _{DS(on)}		orain to Source On Res	Istance	V _{GS} = 10 V V _{DS} = 5 V,			-	1.13	1.5	mΩ
9FS	Forward	d Transconductance		v _{DS} = 5 v,	$I_D = 50 \text{ A}$		-	171	-	S
Dynamic C	haracte	eristics								
C _{iss}	Input C	Capacitance					-	6560	8725	pF
C _{oss}	Output	Capacitance		V _{DS} = 20 V, V _{GS} = 0 V f = 1 MHz		-	2795	3720	pF	
C _{rss}	Reverse	e Transfer Capacitance	Fransfer Capacitance						-	pF
C _{oss} (er)	Energy	Releted Output Capaci	itance	V _{DS} = 20 V	, V _{GS} = 0 V		-	3896	-	pF
Q _{g(tot)}	Total Ga	Gate Charge at 10V					-	91	118	nC
Q _{gs}	Gate to	Source Gate Charge		$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 50 \text{ A}$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ (Note 4)		-	26	-	nC	
Q _{gs2}	Gate Cl	harge Threshold to Plat	teau			-	9	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge				-	16	-	nC	
ESR	Equival	ent Series Resistance		f = 1 MHz			-	1.4	-	Ω
Switching	Charac	teristics								
t _{d(on)}	1	n Delay Time					-	34	78	ns
t _r		n Rise Time		V _{DD} = 20 V, I _D = 50 A		-	24	58	ns	
t _{d(off)}	Turn-Of	Turn-Off Delay Time		$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$			-	71	152	ns
t _f		f Fall Time		(Note 4)			-	26	62	ns
		de Characteristic				. ,				
	1								100	•
s		kimum Continuous Drain to Source D kimum Pulsed Drain to Source Diode				-	-	100	A	
I _{SM}		Source Diode Forward		V _{GS} = 0 V,			-	-	400	A
V _{SD}	_	Recovery Time	i vollage		-		-	- 78	1.3	-
t _{rr}		Recovery Charge	_	V _{GS} = 0 V, I _{SD} = 50 A dI _F /dt = 100 A/μs		-	90	-	ns nC	
Q _{rr}	I CEVEI 3C	e Recovery Charge	urr/ur = 100 A/μs		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		-	30	-	no

3. L = 3 mH, I_{AS} = 18.72 A, starting T_J = 25°C. 4. Essentially independent of operating temperature typical characteristics.

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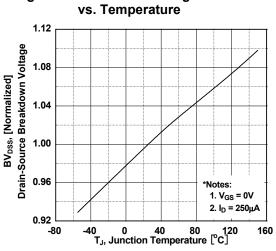
2. Repetitive rating: pulse-width limited by maximum junction temperature.

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Typical Performance Characteristics (Continued) Figure 7. Breakdown Voltage Variation Fi





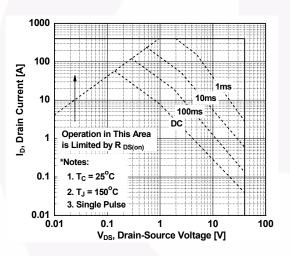
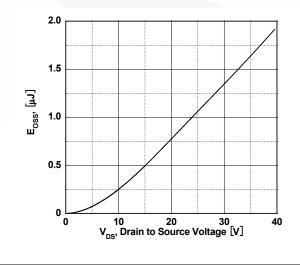
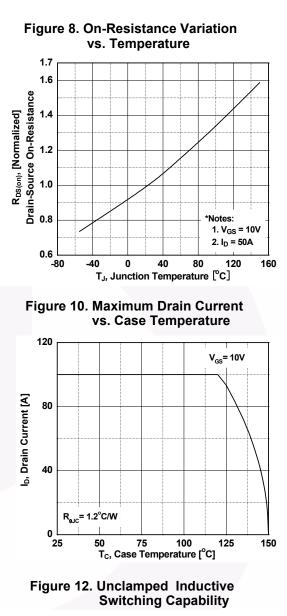
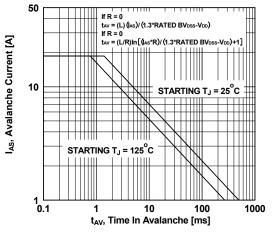


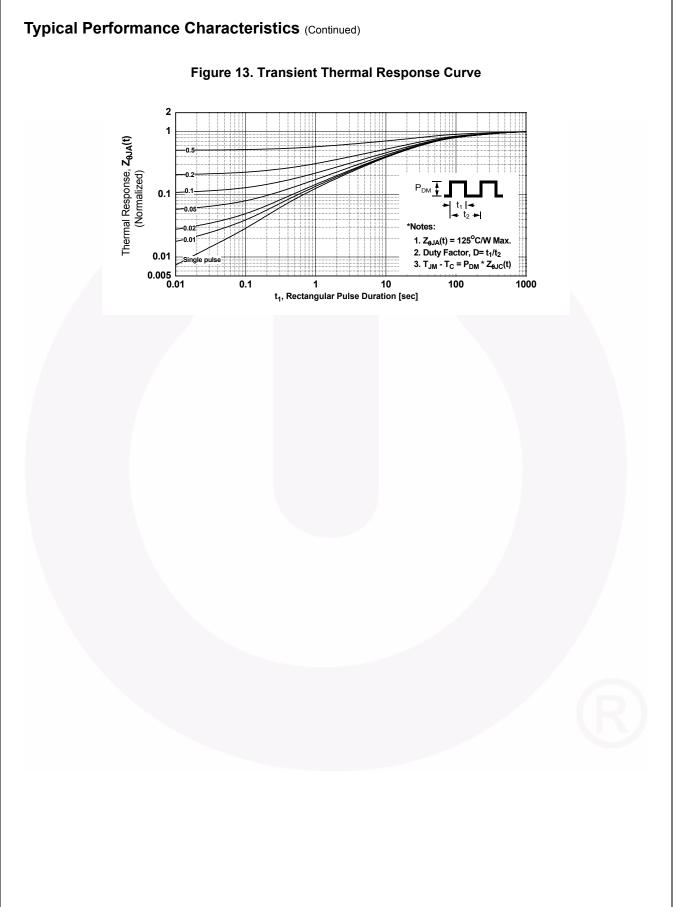
Figure 11. Eoss vs. Drain to Source Voltage

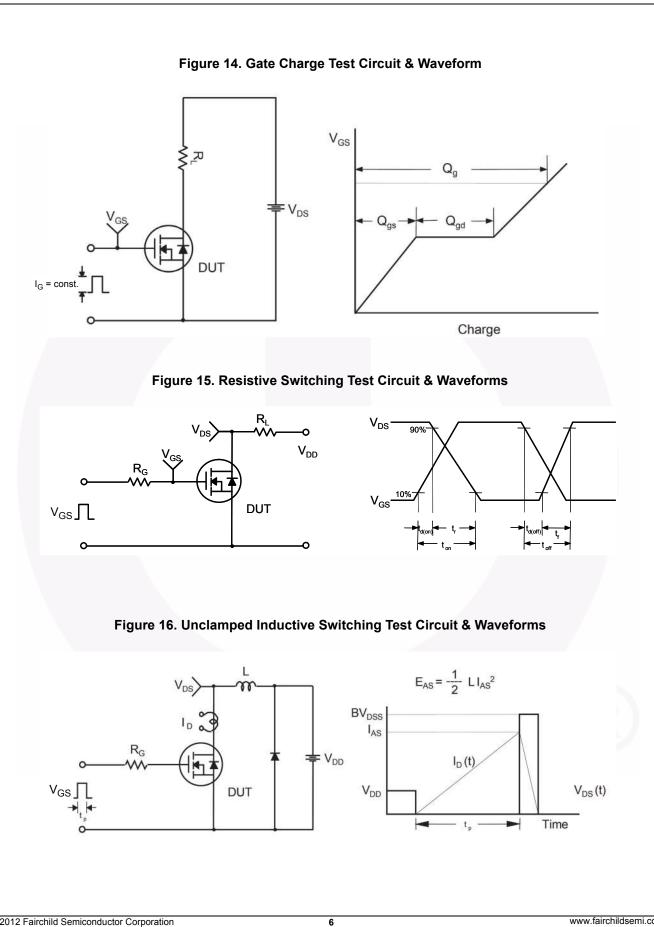






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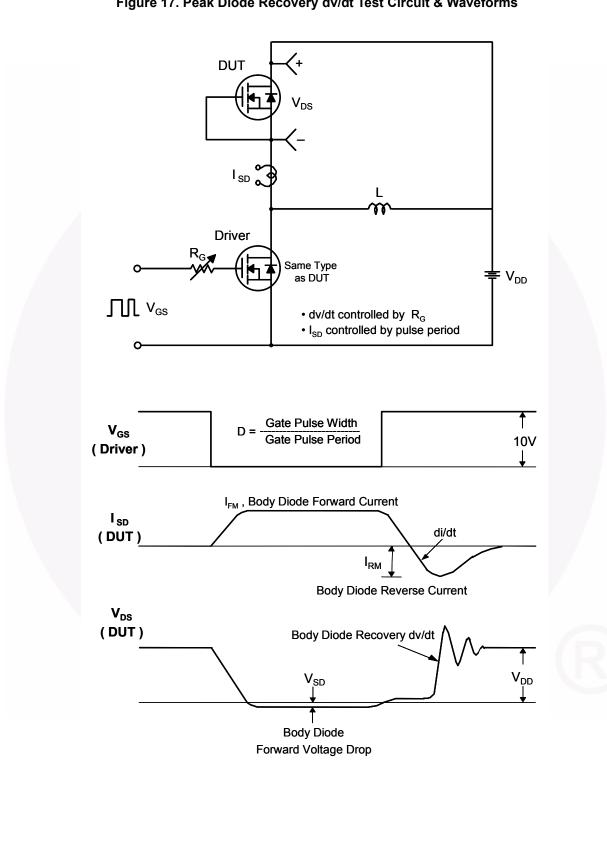
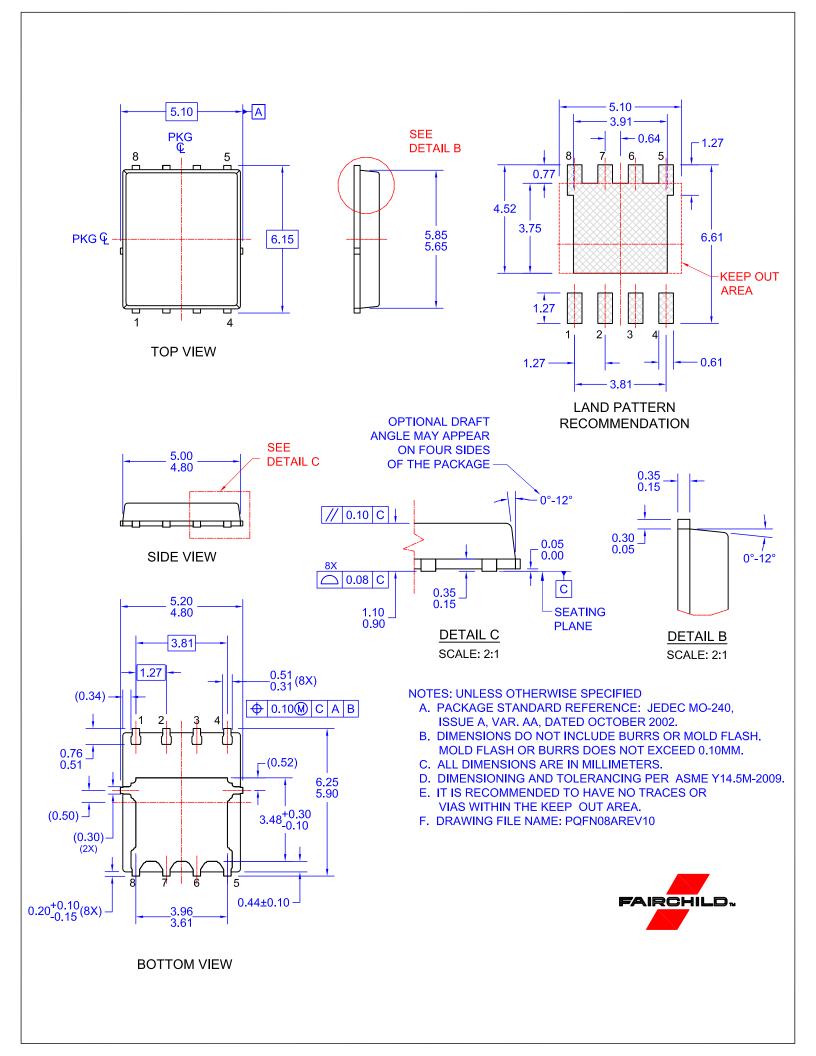
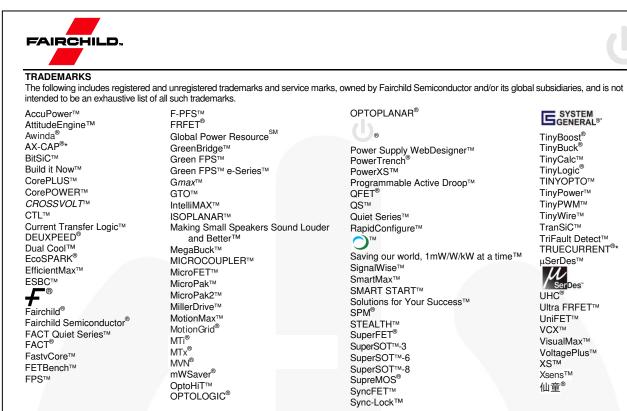


Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms





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